

Thermal Management Solutions

Technical Data Sheet

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HTS Silicone Heat Transfer Compound

HTS is a non-curing heat transfer paste, designed for use as a thermal interface material. It is recommended where the efficient and reliable thermal coupling of electronic components or heat dissipation between any surfaces are required. HTS is based on a silicone oil, offering an exceptionally wide operating temperature range.

- General purpose thermal management paste; excellent stability in a range of conditions
- Based on a silicone oil; offers an exceptionally wide operating temperature range
- Good thermal conductivity; designed for use as a thermal interface material
- Non-curing paste; allows simple and efficient rework of components if required

Approvals

RoHS-2 Compliant (2011/65/EU):
NATO Stock No. – EHTS20S:

Yes
5999-99-225-2132

Typical Properties

Colour:	White
Base:	Silicone Oil
Thermo-conductive Component:	Powdered metal oxides
Density @ 20°C (g/ml):	2.1
Cone Penetration @ 20°C:	300
Viscosity @ 1rpm (Pa s):	201-227
Thermal Conductivity (Guarded Hot Plate):	0.9 W/m.K
Thermal Conductivity (Heat Flow):	0.7 W/m.K (calculated)
Temperature Range:	-50°C to +200°C
Weight Loss after 96 hours @ 100°C:	0.8%
Permittivity @ 10 ⁶ Hz:	4.9
Specific Resistance:	1 x 10 ¹⁵ Ohms/cm
Dielectric Strength:	18 kV/mm

Description

Packing

Order Code

Shelf Life

Silicone Heat Transfer Compound

2 ml Syringe
10ml Syringe
30ml Syringe
35 ml Luer Lock Syringe
1 Kg Bulk
25 Kg Bulk

HTS02S
HTS10S
HTS30SL
HTS35SL
HTS01K
HTS25K

48 months
48 months
48 months
48 months
72 months
72 months

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All information is given in good faith but without warranty. Properties are given as a guide only and should not be taken as a specification.

Electrolube cannot be held responsible for the performance of its products within any application determined by the customer, who must satisfy themselves as to the suitability of the product.

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Directions for Use

Thermal pastes can be applied to the base and mounting studs of diodes, transistors, thyristors, heat sinks, silicone rectifiers and semi-conductors, thermostats, power resistors and radiators, to name but a few. When the contact surfaces are placed together, a firm metal-to-metal contact will only be achieved on 40 – 60% of the interface, depending on the smoothness of the surfaces. This means that air, which has relatively poor thermal conductivity, will account for the balance of the interface. Only a small amount of compound is required to fill these spaces and thus dramatically increase the effective surface area for heat transfer.

It is important to note that the quality of application of a thermal paste can be as important as the thermal conductivity of the material applied; best results are achieved when a uniform, thin coat is applied between the mating surfaces. Apply a thin layer of compound to one of the contact surfaces using a brush, spatula, roller, automated system or screen printing technique. Ensure that the entire interface is covered to avoid hot-spots from forming. Any excess paste squeezed out during the mounting process should be removed.

Additional Information

There are many methods of measuring thermal conductivity, resulting in large variances in results. Electrolube utilise a heat flow method which takes into account the surface resistance of the test substrate, thus offering highly accurate results of true thermal conductivity. Some alternative methods do not account for such surface resistance and can create the illusion of higher thermal conductivity. Therefore, when comparing thermal conductivity measurements it is important to know what test method has been utilised. For more information please contact the Electrolube Technical Department.

The rate at which heat flows is dependent on the temperature differential, the thickness and uniformity of the layer, and the thermal conductivity of the material. Products with the same comparable thermal conductivity value may have very different efficiencies of heat transfer in the end application depending on how successfully a thin even film can be applied.

A full range of heat transfer products are available from Electrolube: high thermal conductivity pastes (HTSP), non-silicone based pastes (HTC), gap filling materials (HTCPX), Silicone RTVs (TCOR, TCER), epoxy adhesives (TBS) and encapsulation resins (ER2220, UR5633, SC2003).

Bulk Packaging Specifications

Package Size	Diameter	Height
700g Cartridge	49.6mm	260mm + 15mm for Nozzle
1Kg Bulk Container	92mm	100mm
25Kg Bulk Container	300mm	285mm

Revision 3: July 2015

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